

Silicon Diode

BYV4100

100V/4A

DATASHEET

OEM – Philips

Source: Philips Databook 1999

Fast soft-recovery controlled avalanche rectifier

BYV4100

FEATURES

- Glass passivated
- High maximum operating temperature
- Low leakage current
- Excellent stability
- Guaranteed avalanche energy absorption capability
- Available in ammo-pack
- Also available with preformed leads for easy insertion.

DESCRIPTION

Rugged glass SOD64 package, using a high temperature alloyed construction.

This package is hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.

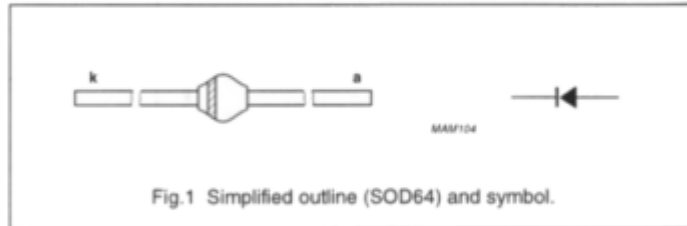


Fig.1 Simplified outline (SOD64) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{RRM}	repetitive peak reverse voltage		–	100	V
V_R	continuous reverse voltage		–	100	V
$I_{F(AV)}$	average forward current	$T_{sp} = 65\text{ °C}$; lead length = 10 mm; averaged over any 20 ms period; see Fig.2; see also Fig.4	–	4.0	A
		$T_{amb} = 60\text{ °C}$; PCB mounting (see Fig.12); averaged over any 20 ms period; see Fig.3; see also Fig.4	–	1.9	A
I_{FRM}	repetitive peak forward current	$T_{sp} = 65\text{ °C}$; see Fig.6	–	34	A
		$T_{amb} = 60\text{ °C}$; see Fig.7	–	17	A
I_{FSM}	non-repetitive peak forward current	$t = 10\text{ ms}$ half sine wave; $T_j = T_{jmax}$ prior to surge; $V_R = V_{RRMmax}$	–	90	A
E_{RSM}	non-repetitive peak reverse avalanche energy	$L = 120\text{ mH}$; $T_j = T_{jmax}$ prior to surge; inductive load switched off	–	20	mJ
T_{stg}	storage temperature		–65	+175	°C
T_j	junction temperature		–65	+175	°C

**Fast soft-recovery
controlled avalanche rectifier**

BYV4100

ELECTRICAL CHARACTERISTICS $T_j = 25\text{ °C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_F	forward voltage	$I_F = 3.5\text{ A}$; $T_j = T_{j\text{max}}$; see Fig.5	–	–	0.78	V
		$I_F = 3.5\text{ A}$; see Fig.5	–	–	0.98	V
$V_{(BR)R}$	reverse avalanche breakdown voltage	$I_R = 0.1\text{ mA}$	120	–	–	V
I_R	reverse current	$V_R = V_{RRM\text{max}}$; see Fig.8	–	–	5	μA
		$V_R = V_{RRM\text{max}}$; $T_j = 165\text{ °C}$; see Fig.8	–	–	150	μA
t_{rr}	reverse recovery time	when switched from $I_F = 0.5\text{ A}$ to $I_R = 1\text{ A}$; measured at $I_R = 0.25\text{ A}$; see Fig.10	–	–	15	ns
C_d	diode capacitance	$f = 1\text{ MHz}$; $V_R = 0\text{ V}$; see Fig.9	–	245	–	pF
$\left \frac{dI_R}{dt} \right $	maximum slope of reverse recovery current	when switched from $I_F = 1\text{ A}$ to $V_R \geq 30\text{ V}$ and $dI_F/dt = -1\text{ A}/\mu\text{s}$; see Fig.11	–	–	2	$\text{A}/\mu\text{s}$

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j\text{-tp}}$	thermal resistance from junction to tie-point	lead length = 10 mm	25	K/W
$R_{th\ j\text{-a}}$	thermal resistance from junction to ambient	note 1	75	K/W

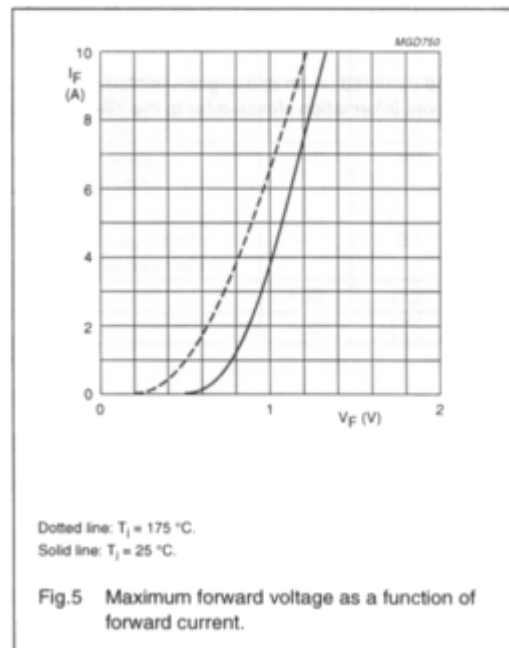
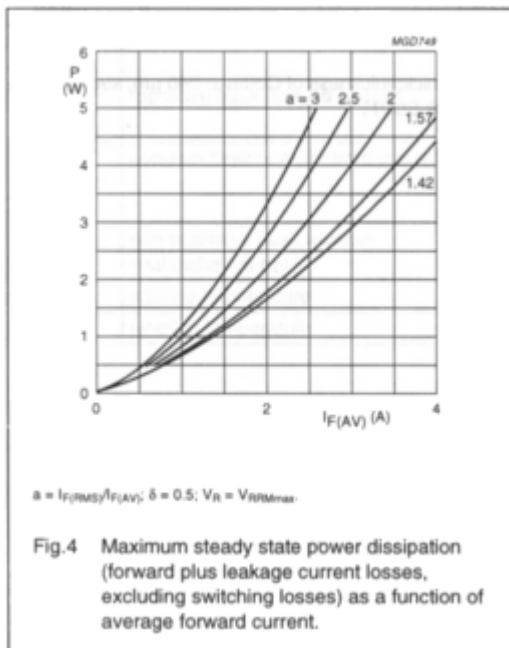
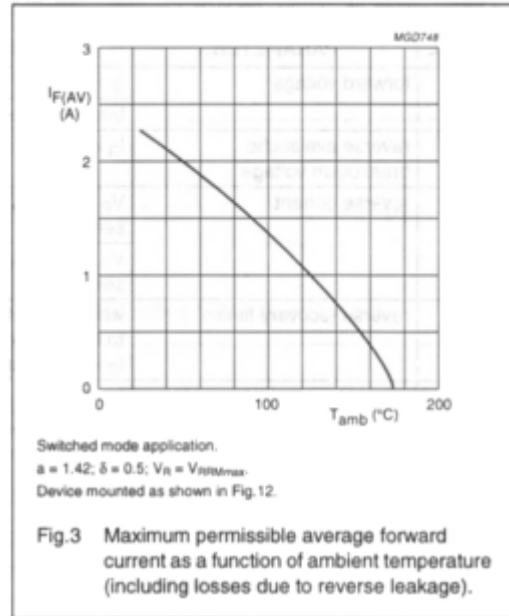
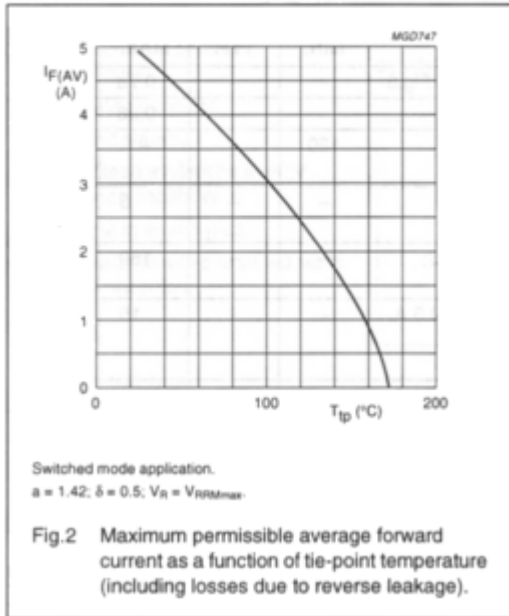
Note

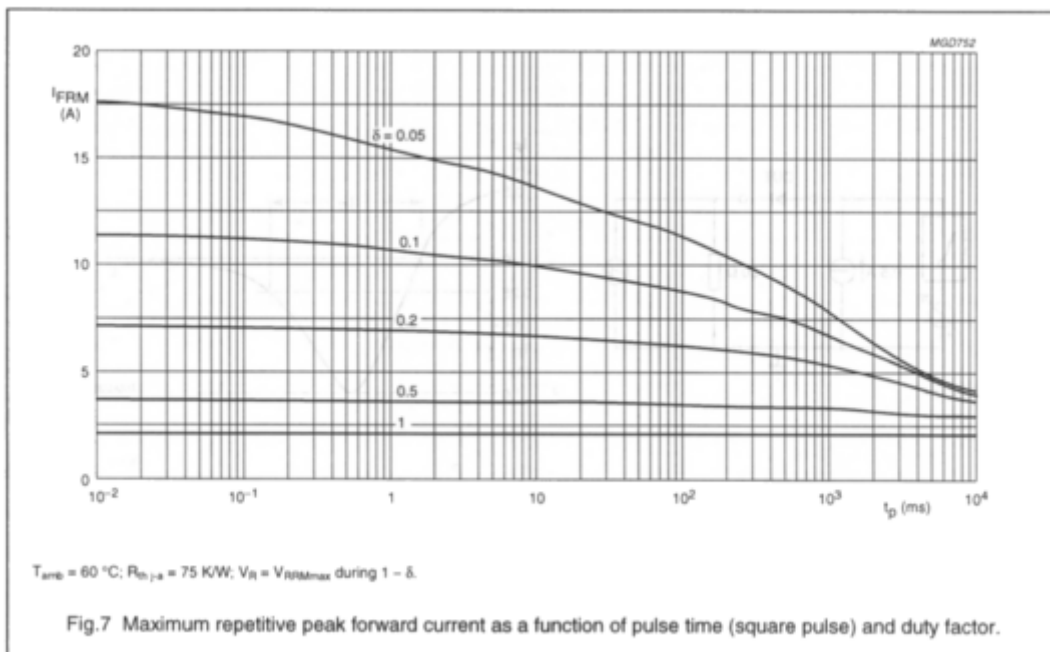
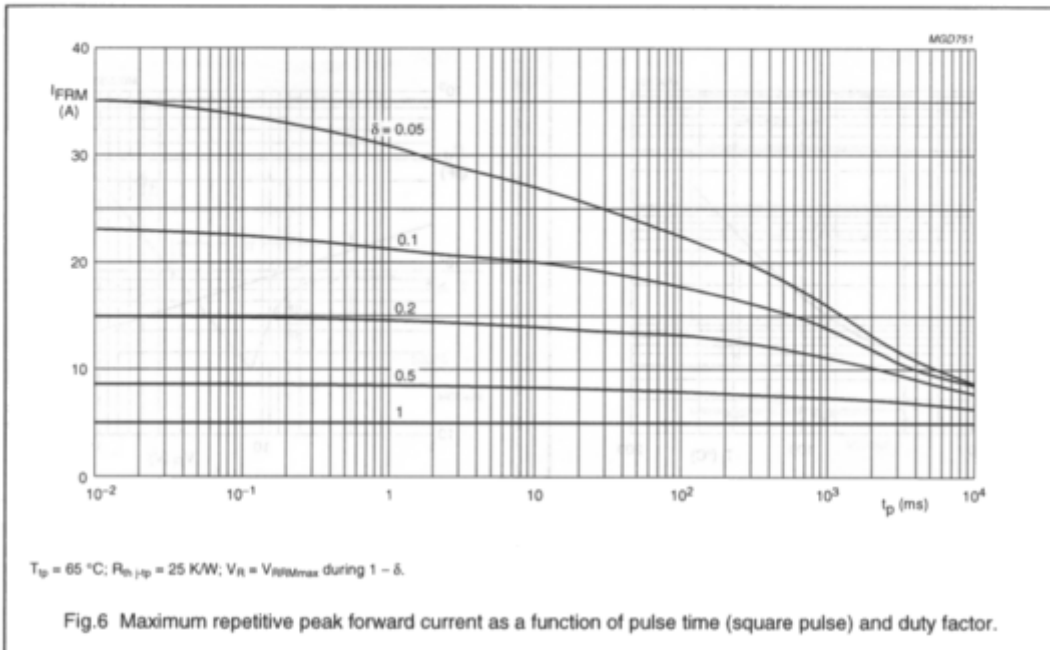
1. Device mounted on an epoxy-glass printed-circuit board, 1.5 mm thick; thickness of Cu-layer $\geq 40\ \mu\text{m}$, see Fig.12. For more information please refer to the 'General Part of Handbook SC01'.

Fast soft-recovery
controlled avalanche rectifier

BYV4100

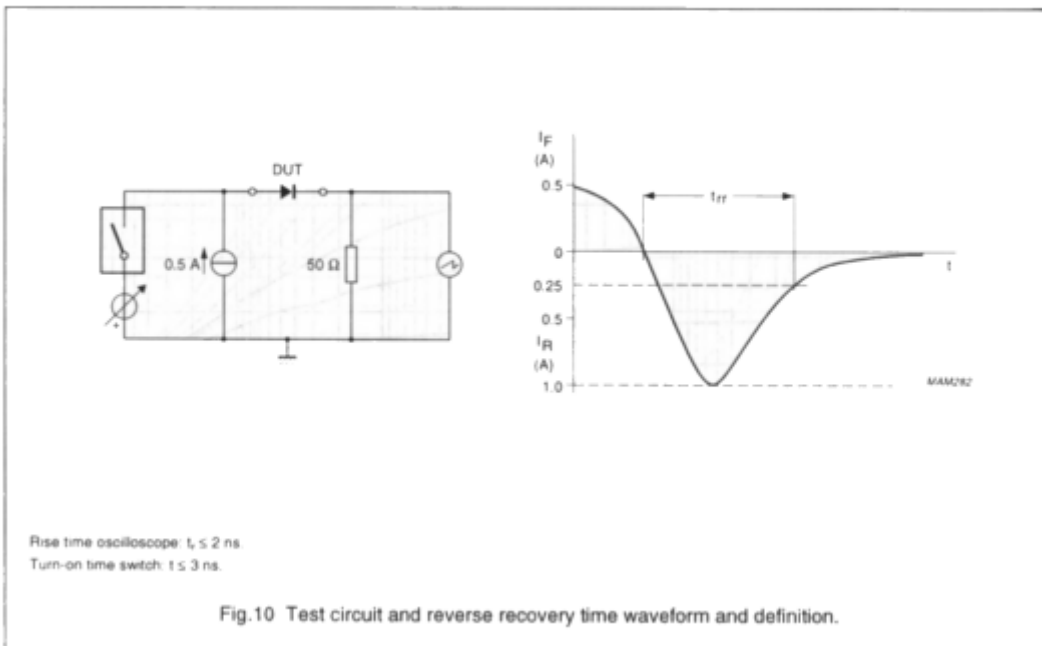
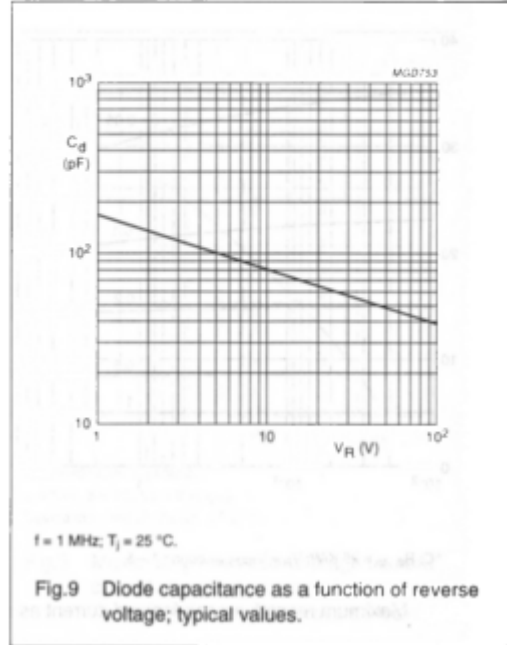
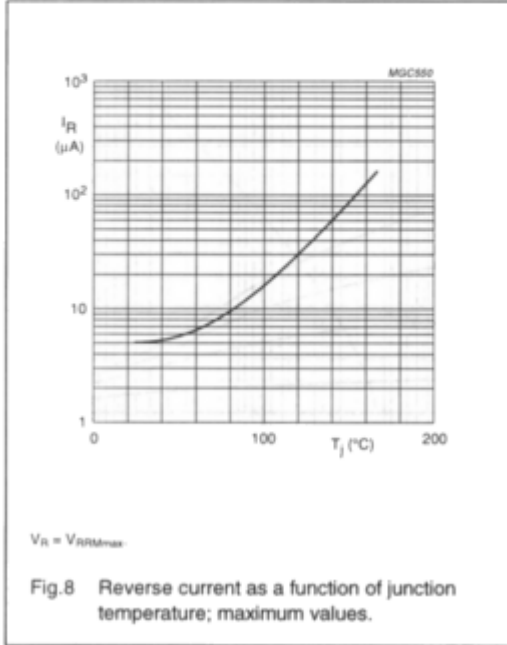
GRAPHICAL DATA



**Fast soft-recovery
controlled avalanche rectifier**
BYV4100


Fast soft-recovery
controlled avalanche rectifier

BYV4100



Fast soft-recovery
controlled avalanche rectifier

BYV4100

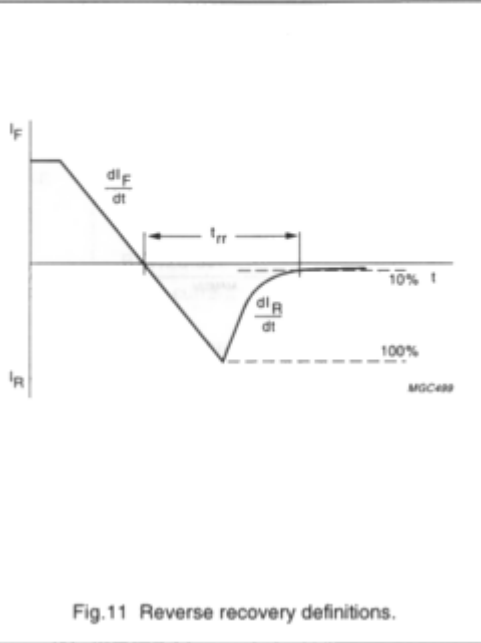
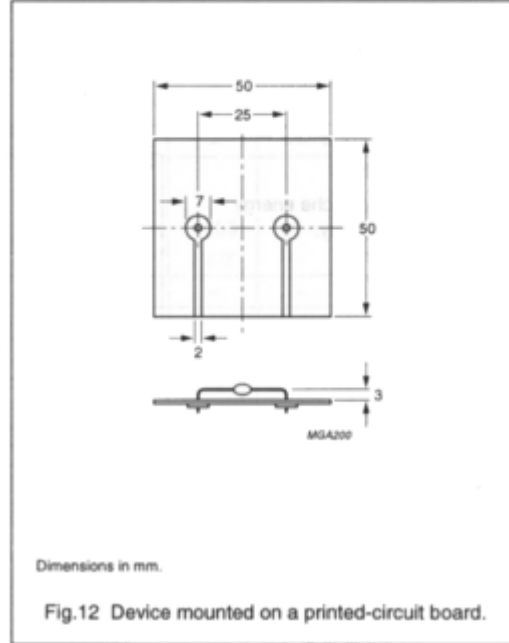


Fig.11 Reverse recovery definitions.



Dimensions in mm.

Fig.12 Device mounted on a printed-circuit board.